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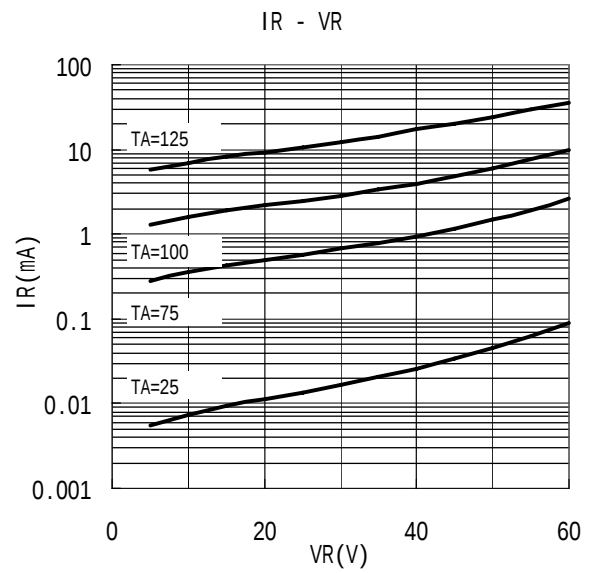
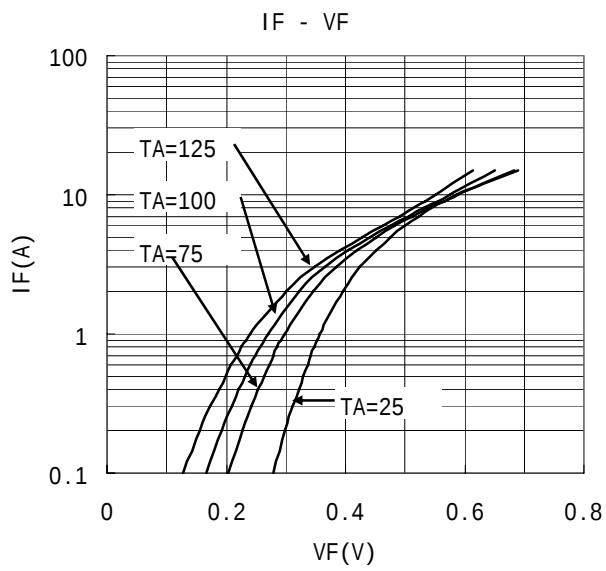
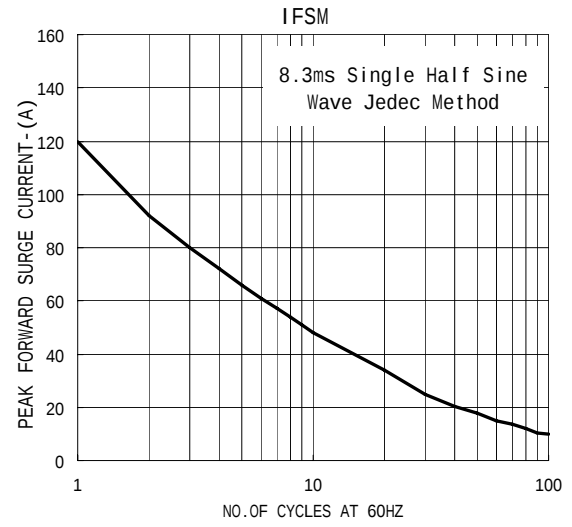
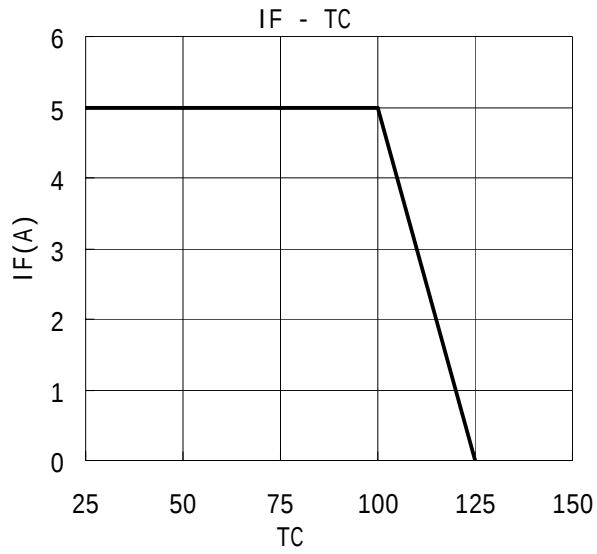
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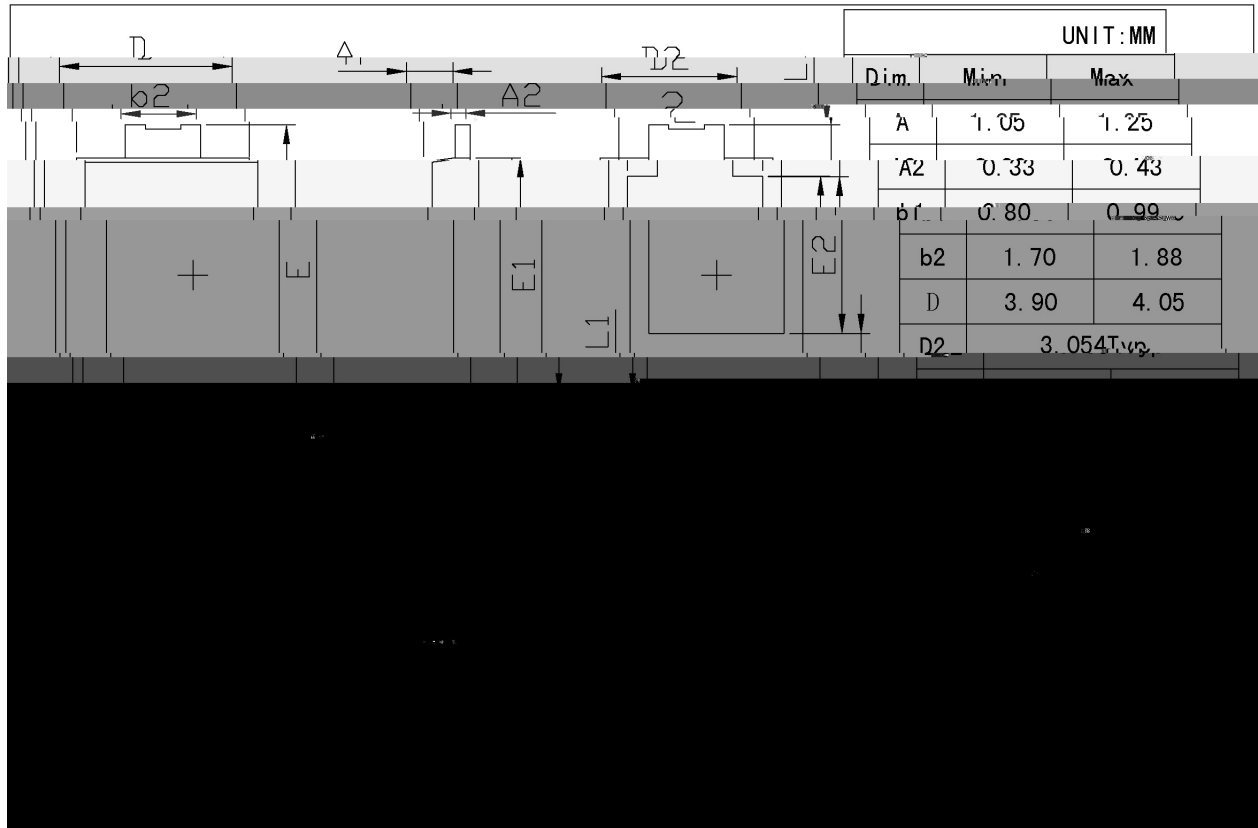
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1. FR-4 PCB 2

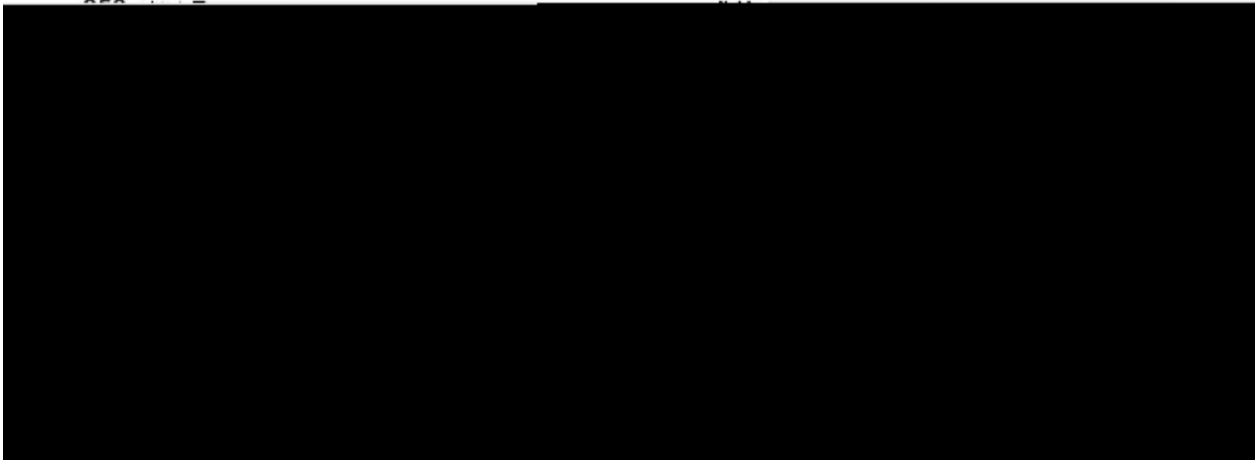
2.

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Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

± ± °C

封装形式	包装数量					包装尺寸		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱		盒	箱